AN7337NS

7-element graphic equalizer IC for Hi-Fi audio equipment

Overview

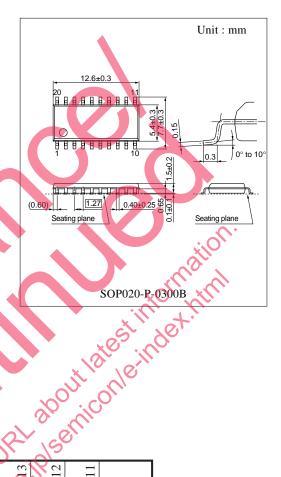
The AN7337NS is a graphic equalizer IC for high performance Hi-Fi audio equipment developed for deck. It incorporates an output buffer circuit and 7 resonance buffer circuits, and can set resonance frequency by external capacitor.

■ Features

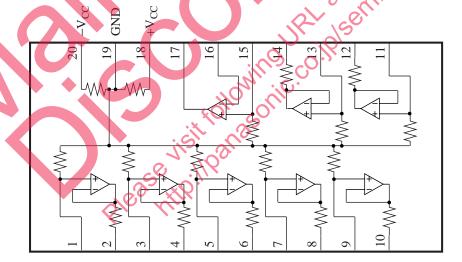
- Low distortion (max.: 0.03%)
- Low noise voltage (input short circuit: max.: 30 $\mu V[rms]$)
- High output voltage (typ. 9.5 V)

Applications

• Mini-component stereo, system component stereo



■ Block Diagram



■ Pin Descriptions

Pin No.	Description	Pin No.	Description
1	In 1	11	In 6
2	NF 1	12	NF 6
3	In 2	13	In 7
4	NF 2	14	NF 7
5	In 3	15	Non-inverting input
6	NF 3	16	Inverting input
7	In 4	17	Output
8	NF 4	18	+ V _{CC}
9	In 5	19	GND
10	NF 5	20	-V _{cc}

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	±18	, K. (),
Supply current	I_{CC}	± 50	mA
Power dissipation *2	$P_{\rm D}$	230	mW
Operating ambient temperature *1	$T_{ m opr}$	-20 to +75	°C
Storage temperature *1	$T_{\rm stg}$	-55 to +125	°C

Note) *1: All items are at $T_a = 25$ °C, except for the operating ambient temperature and storage temperature.

■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V _{CC}	$\pm 4.0 \text{ to } \pm 18.0$	V

■ Electrical Characteristics at V_{CC} = ±15 V, T_a = 25°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Total circuit current	I_{CC}	$V_{IN} = 0 \text{ mV}$	8	12	16	mA
Voltage gain FLAT	G _{V(FLAT)}	$f = 1 \text{ kHz}, V_{IN} = -10 \text{ dBm}$	- 0.6	- 0.3	0	dB
Voltage gain BOOST	G _V	FLAT $V_O = 0$ dB, $V_{IN} = -10$ dBm	10.4	12.0	14.0	dB
	(BOOST)					
Voltage gain CUT	G _{V(CUT)}	FLAT $V_O = 0$ dB, $V_{IN} = -10$ dBm	-14.0	-12.0	-10.4	dB
Total harmonic distortion	THD	$f = 1 \text{ kHz}, V_O = 1 \text{ V[rms]}$	_	0.002	0.03	%
Max. output voltage	V _{OM}	f = 1 kHz, THD = 0.1%	8.0	9.5	_	V[rms]
Output noise voltage	V _{NO}	Input short circuit DIN AUDIO	_	4	30	μV[rms]
Output noise voltage	V _{NOM}	Input short circuit DIN AUDIO All Boost	_	31	100	μV[rms]

^{*2:} Referring to " \blacksquare Technical Information" for power dissipation at $T_a = 75$ °C, use the circuit under the conditions of the $V_{CC} \times I_{CC}$ is not exceeding the P_D max.

■ Electrical Characteristics at $V_{CC} = \pm 15 \text{ V}$, $T_a = 25^{\circ}\text{C}$ (continued)

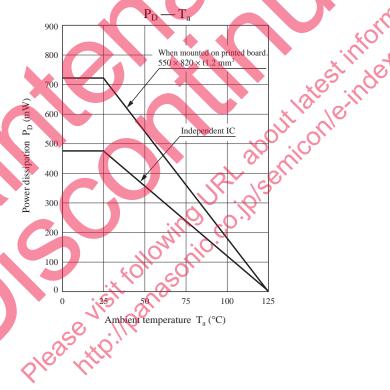
• Design reference data

Note) The following characteristics are the reference values for design and not guaranteed values.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Resonance frequency	f _{O1}	$V_{IN} = -10 \text{ dBm}, V_O = G_{V \text{ PEAK}}$	47.3	57	73.6	Hz
Resonance frequency	f _{O2}	$V_{IN} = -10 \text{ dBm}, V_O = G_{V \text{ PEAK}}$	93.3	113	145	Hz
Resonance frequency	f _{O3}	$V_{IN} = -10 \text{ dBm}, V_O = G_{V \text{ PEAK}}$	285	347	444	Hz
Resonance frequency	f _{O4}	$V_{IN} = -10 \text{ dBm}, V_O = G_{V \text{ PEAK}}$	0.851	1.04	1.32	kHz
Resonance frequency	f _{O5}	$V_{IN} = -10 \text{ dBm}, V_O = G_{V \text{ PEAK}}$	1.98	2.41	3.08	kHz
Resonance frequency	f _{O6}	$V_{IN} = -10 \text{ dBm}, V_O = G_{V \text{ PEAK}}$	5.23	6.37	8.14	kHz
Resonance frequency	f _{O7}	$V_{IN} = -10 \text{ dBm}, V_{O} = G_{V \text{ PEAK}}$	12.4	15.1	19.3	kHz

■ Technical Information

• P_D — T_a curves of SOP020-P-0300B



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